

# cut C400

## The contact-free depaneling

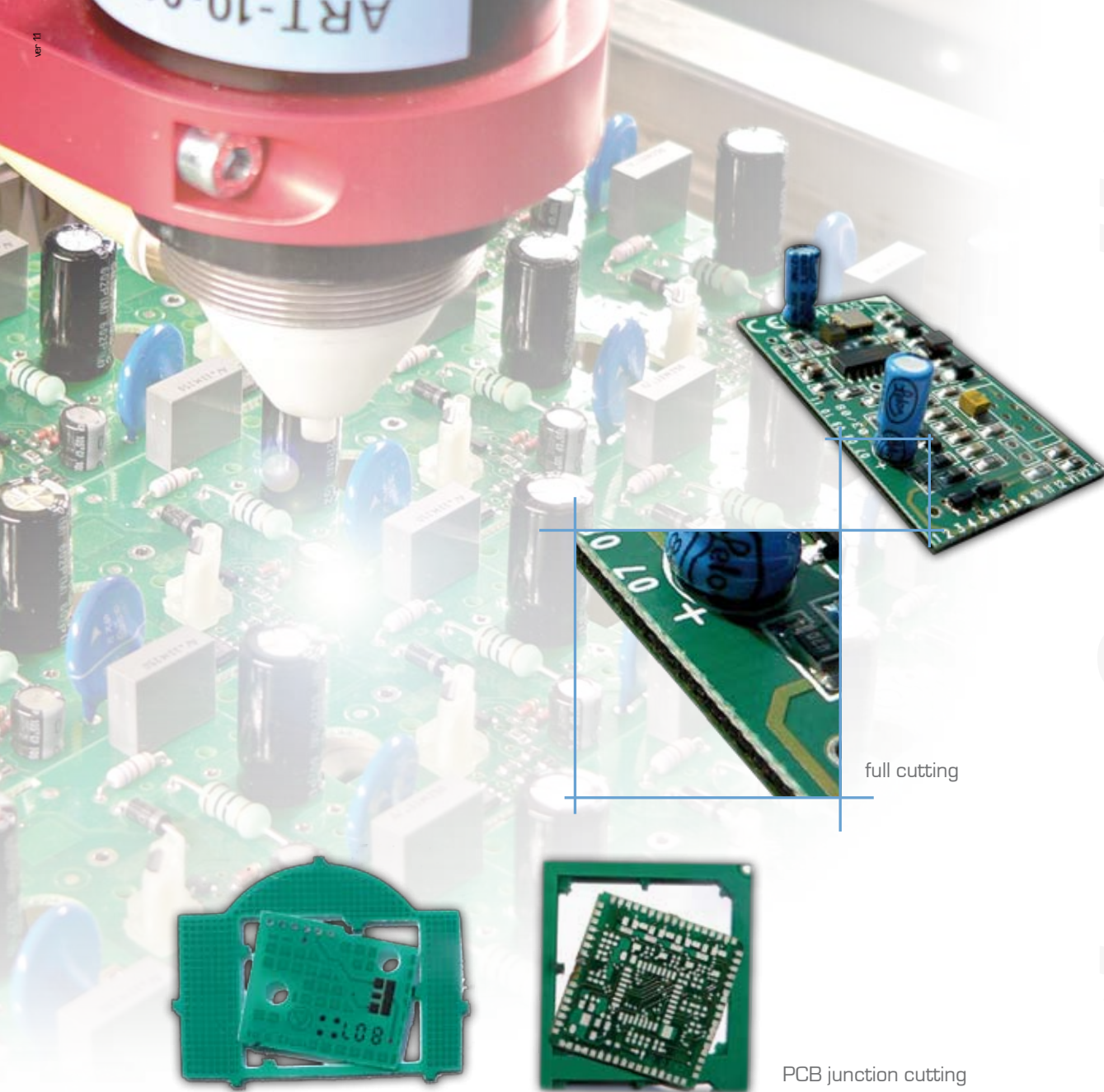
The execution of the depaneling process by means of laser represents the optimal method to obtain a fast cut, remarkably reducing the time of boards separating/cutting.

The Neocut laser cut, based on the innovative *OSAI Laser Cut Technology*, is the only process/method that doesn't damage the components due to the complete absence of mechanical stress.

The easy software programming, also usable off-line, allows to quickly generate cutting programs according to different boards types, including an important reduction of the machine's equipping.



# neocut C400



full cutting

PCB junction cutting

## FEATURES

DIMENSIONS	L 1200 - D 1350 - H 1800 mm
WEIGHT	≈ 1.400 Kg
WORKING AREA	400 x 400 mm
LASER SAFETY	CLASS 1 (EN60825-1)
CUTTING SPEED	2,0 m/min
CUTTING WIDTH	0,150 mm
BOARD THICKNESS	up to 3 mm
ACCESS TO THE WORKING AREA	Frontal drawer with laser light filte
MAN/MACHINE INTERFACE	By PC with LCD monitor and keyboard. Console with set-up buttons
SYSTEM MANAGEMENT SOFTWARE	Intuitive and graphic, interface with the information system to communicate coding and production data
LASER SOURCES	CO2
LASER POWER	70 W
CONFIGURATION/OPTIONS	Fumes exhaust and activated carbon